



Chip Type, High Reliability.  
Low temperature ESR specification.  
series



- Chip type, high temperature range, for +125°C use.
- Added ESR specification after the test at -40°C (φ6.3 sizes provide only for the first stage.)
- Applicable to automatic mounting machine using carrier tape.
- Adapted to the RoHS directive (2002/95/EC).



Added ESR specification at -40°C UB



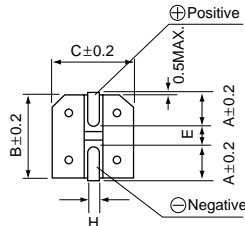
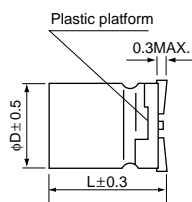
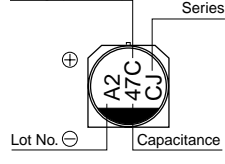
## Specifications

Item	Performance Characteristics						
Category Temperature Range	-40 to +125°C						
Rated Voltage Range	10 to 50V						
Rated Capacitance Range	10 to 470μF						
Capacitance Tolerance	±20% at 120Hz, 20°C						
Leakage Current	After 1 minute's application of rated voltage, leakage current is not more than 0.03CV or 4(μA) , whichever is greater.						
tan δ	Measurement frequency : 120Hz, Temperature : 20°C						
	Rated voltage (V)	10	16	25	35	50	
	tan δ (MAX.)	0.32	0.24	0.21	0.18	0.18	
Stability at Low Temperature	Measurement frequency : 120Hz						
	Rated voltage (V)		10	16	25	35	50
	Impedance ratio ZT / Z20 (MAX.)	Z-40°C / Z+20°C	12	8	6	4	4
Endurance	After 2000 hours' application of rated voltage at 125°C, capacitors meet the characteristic requirements listed at right.				Capacitance change		Within ±30% of initial value
					tan δ		300% or less of initial specified value
					Leakage current		Initial specified value or less
Shelf Life	After storing the capacitors under no load at 125°C for 1000 hours, and after performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they will meet the specified value for endurance characteristics listed above.						
Resistance to soldering heat	The capacitors shall be kept on the hot plate maintained at 250°C for 30 seconds. After removing from the hot plate and restored at room temperature, they meet the characteristic requirements listed at right.				Capacitance change		Within ±10% of initial value
tan δ					Initial specified value or less		
Leakage current					Initial specified value or less		
Marking	Black print on the case top.						

## Chip Type

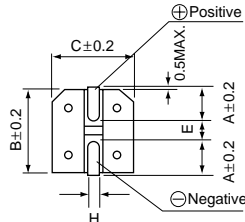
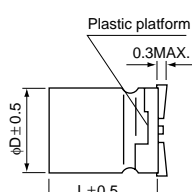
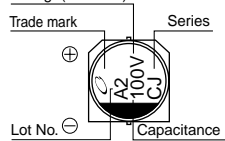
(φ6.3 × 8.7)

Voltage (C : 16V)

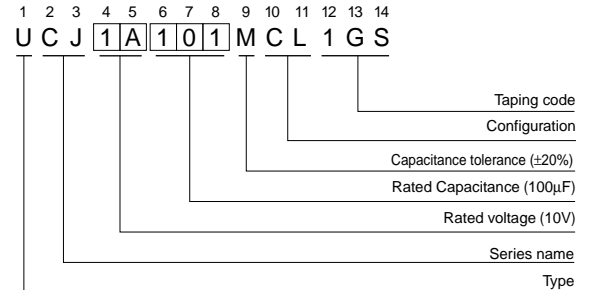


(φ8 × 10, φ10 × 10)

Voltage (V : 35V)



## Type numbering system (Example : 10V 100μF)



φD × L	6.3 × 8.7	8 × 10	10 × 10
A	2.4	2.9	3.2
B	6.6	8.3	10.3
C	6.6	8.3	10.3
E	2.2	3.1	4.5
L	8.7	10	10
H	0.5 to 0.8	0.8 to 1.1	0.8 to 1.1

## Dimensions

V		10			16			25			35			50		
Cap. (μF)	Code	1A			1C			1E			1V			1H		
10	100															
22	220							6.3 × 8.7	14	-	95	6.3 × 8.7	14	-	95	6.3 × 8.7
33	330							6.3 × 8.7	14	-	95	6.3 × 8.7	14	-	95	6.3 × 8.7
47	470							6.3 × 8.7	14	-	95	6.3 × 8.7	14	-	95	8 × 10
100	101	6.3 × 8.7	14	-	95	8 × 10	2.0	6.0	250	8 × 10	2.0	6.0	250	10 × 10	1.5	4.5
220	221	8 × 10	2.0	6.0	250	10 × 10	1.5	4.5	400	10 × 10	1.5	4.5	400	10 × 10	1.5	4.5
330	331	10 × 10	1.5	4.5	400	10 × 10	1.5	4.5	400	10 × 10	1.5	4.5	400			
470	471	10 × 10	1.5	4.5	400											

Max. ESR (Ω) at -40°C 100kHz, Rated Ripple (mArms) at 125°C 100kHz

## Frequency coefficient of rated ripple current

Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
Coefficient	0.35	0.50	0.64	0.83	1.00

- Taping specifications are given in page 23.
- Recommended land size, soldering by reflow are given in page 18, 19.
- Please refer to page 3 for the minimum order quantity.